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Schottky Barrier Rectifier in SOD-123FL

Features

- Schottky barrier diodes
- Low forward voltage drop
- High Tunction Temperature
- Moisture sensitivity: level 1, per J-STD-020



Mechanical Data

- Case: SOD-123FL (plastic package). Lead free; RoHS compliant
- Molding Compound Flammability Rating: UL 94 V-0
- **Terminals:** High temperature soldering guaranteed: 260 °C/10 sec. at terminals

Applications

For use of fast swiching in RF module, Lighting, cellular phone, portable device, power supplies and other consumer applications.

Absolute Maximum Ratings Ratings at 25 °C, ambient temperature unless otherwise specified							
Parameter	Symbol	SS22FL	SS23FL	SS24FL	SS26FL	SS210FL	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	60	100	V
Maximum RMS voltage	V_{RMS}	14	21	28	42	70	V
Maximum DC blocking voltage	V_{DC}	20	30	40	60	100	V
Maximum average forward rectified current	I _{F(AV)}		•	2.0	•		Α
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	40		Α			
Operating junction and storage temperature range	T_J, T_{STG}		-	55 to + 15	0		С

Electrical Characteristics								
(T _A = 25 °C unless otherwise specified)								
Parameter	Test Conditions	Symbol	SS22FL	SS23FL	SS24FL	SS26FL	SS210FL	Unit
Maximum instantaneous forward voltage	I _F =2A, T _A =25℃	V _F	0.55		0.70	0.85	V	
Maximum DC reverse current	T _A =25℃	I_	0.5		mA			
at rated DC blocking voltage	T _A =125℃	^I R 50		10	ША			
Typical junction capacitance	4.0 V, 1 MHz	C _J	220 180		80	pF		

Thermal Characteristics							
Parameter	Symbol	SS22FL	SS23FL	SS24FL	SS26FL	SS210FL	Unit
	$R_{\theta JA}$	95					
Typical thermal resistance ⁽¹⁾	$R_{\theta JC}$	60				°C/W	
	$R_{\theta JI}$			35			

Note1:Thermal resistance from junction to lead, mounted on PCB with 5.0×5.0mm copper pads



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Typical Characteristics (T_{amb} = 25 °C unless otherwise specified)

Figure 1.Forward Current Derating Curve

Build B

Figure 2.Maximum Non-Repetitive Peak Forward Surge Current

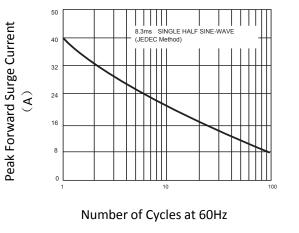


Figure 3. Typical Instantaneous Forward Characteristics

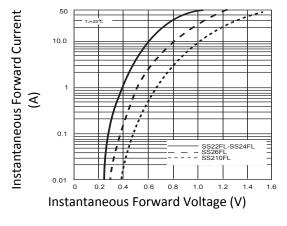


Figure 4. Typical Reverse Characteristics

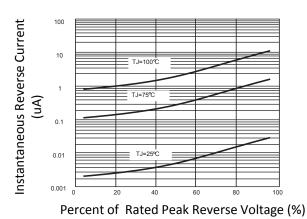
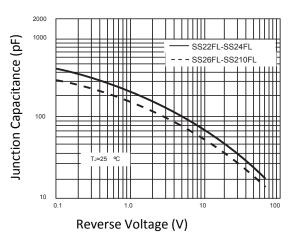


Figure 5. Typical Junction Capacitance

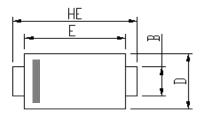


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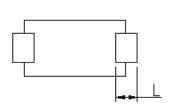
Package Dimensions



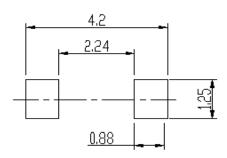


DIM	Unit: mm		Unit: inch		
	MIN	MAX	MIN	MAX	
Α	0.9	1.08	0.035	0.043	
A1	0	0.1	0.000	0.004	
В	0.85	1.05	0.033	0.041	
С	0.1	0.25	0.004	0.010	
D	1.7	2	0.067	0.079	
E	2.9	3.1	0.114	0.122	
L	0.43	0.83	0.017	0.033	
HE	3.5	3.9	0.138	0.154	

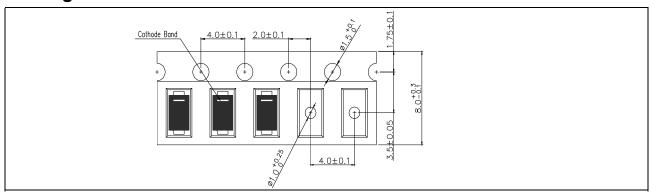




Soldering footprint



Package Information



Marking



Ordering information

Order code	Package	Packaging option	Base quantity	Packaging specification
SS22FL Thur SS210FL	SOD-123FL	Tape and reel	3000pcs / reel	EIA STD RS-481

Revision history

Date	Revision	Changes
23-May-2012	1.0	Initial release
28-Mar2019	2.0	Add Marking



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